

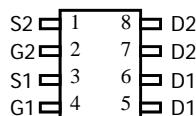


**ALPHA & OMEGA**  
SEMICONDUCTOR, LTD.

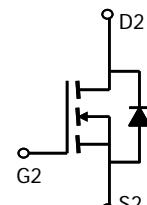
Rev 1: June 2004

## AO4612, AO4612L (Green Product) Complementary Enhancement Mode Field Effect Transistor

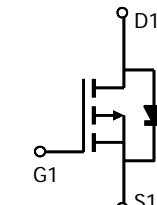
General Description	Features												
<p>The AO4612 uses advanced trench technology MOSFETs to provide excellent <math>R_{DS(ON)}</math> and low gate charge. The complementary MOSFETs may be used in H-bridge, Inverters and other applications. AO4612L (Green Product) is offered in a lead-free package.</p>	<table> <tbody> <tr> <td>n-channel</td> <td>p-channel</td> </tr> <tr> <td><math>V_{DS}</math> (V) = 60V</td> <td>-60V</td> </tr> <tr> <td><math>I_D</math> = 4.5A</td> <td>-3.2A</td> </tr> <tr> <td><math>R_{DS(ON)}</math></td> <td><math>R_{DS(ON)}</math></td> </tr> <tr> <td>&lt; 56mΩ (<math>V_{GS}</math>=10V)</td> <td>&lt; 105mΩ (<math>V_{GS}</math> = -10V)</td> </tr> <tr> <td>&lt; 77mΩ (<math>V_{GS}</math>=4.5V)</td> <td>&lt; 135mΩ (<math>V_{GS}</math> = -4.5V)</td> </tr> </tbody> </table>	n-channel	p-channel	$V_{DS}$ (V) = 60V	-60V	$I_D$ = 4.5A	-3.2A	$R_{DS(ON)}$	$R_{DS(ON)}$	< 56mΩ ( $V_{GS}$ =10V)	< 105mΩ ( $V_{GS}$ = -10V)	< 77mΩ ( $V_{GS}$ =4.5V)	< 135mΩ ( $V_{GS}$ = -4.5V)
n-channel	p-channel												
$V_{DS}$ (V) = 60V	-60V												
$I_D$ = 4.5A	-3.2A												
$R_{DS(ON)}$	$R_{DS(ON)}$												
< 56mΩ ( $V_{GS}$ =10V)	< 105mΩ ( $V_{GS}$ = -10V)												
< 77mΩ ( $V_{GS}$ =4.5V)	< 135mΩ ( $V_{GS}$ = -4.5V)												



SOIC-8



n-channel



p-channel

### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Max n-channel	Max p-channel	Units
Drain-Source Voltage	$V_{DS}$	60	-60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	$\pm 20$	V
Continuous Drain Current <sup>A</sup>	$I_D$	4.5	-3.2	A
$T_A=70^\circ\text{C}$		3.6	-2.6	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	20	-20	
Power Dissipation	$P_D$	2	2	W
$T_A=70^\circ\text{C}$		1.28	1.28	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	-55 to 150	°C

### Thermal Characteristics: n-channel and p-channel

Parameter	Symbol	Device	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	n-ch	48	62.5	°C/W
Steady-State		n-ch	74	110	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	n-ch	35	60	°C/W
Steady-State		p-ch	48	62.5	°C/W
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	p-ch	74	110	°C/W
Steady-State		p-ch	35	40	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	p-ch			
Steady-State					

**N Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	60			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=48\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			1 5	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$			100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	2.1	3	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS}=10\text{V}, V_{DS}=5\text{V}$	20			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=4.5\text{A}$ $T_J=125^\circ\text{C}$		46 79	56	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=3\text{A}$		64	77	$\text{m}\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=4.5\text{A}$		11		S
$V_{SD}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.74	1	V
$I_S$	Maximum Body-Diode Continuous Current				3	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=30\text{V}, f=1\text{MHz}$		450	540	pF
$C_{oss}$	Output Capacitance			60		pF
$C_{rss}$	Reverse Transfer Capacitance			25		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		1.65	2	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=30\text{V}, I_D=4.5\text{A}$		8.5	10.5	nC
$Q_g(4.5\text{V})$	Total Gate Charge			4.3	5.5	nC
$Q_{gs}$	Gate Source Charge			1.6		nC
$Q_{gd}$	Gate Drain Charge			2.2		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=30\text{V}, R_L=6.7\Omega, R_{\text{GEN}}=3\Omega$		4.7		ns
$t_r$	Turn-On Rise Time			2.3		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			15.7		ns
$t_f$	Turn-Off Fall Time			1.9		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=4.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$		27.5	35	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=4.5\text{A}, dI/dt=100\text{A}/\mu\text{s}$		32		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using 80  $\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: N-CHANNEL**

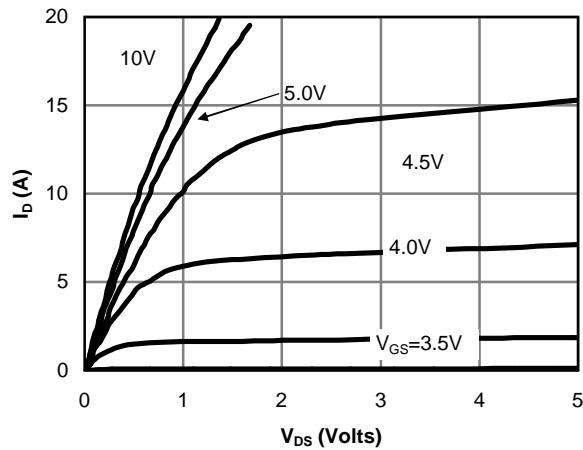


Fig 1: On-Region Characteristics

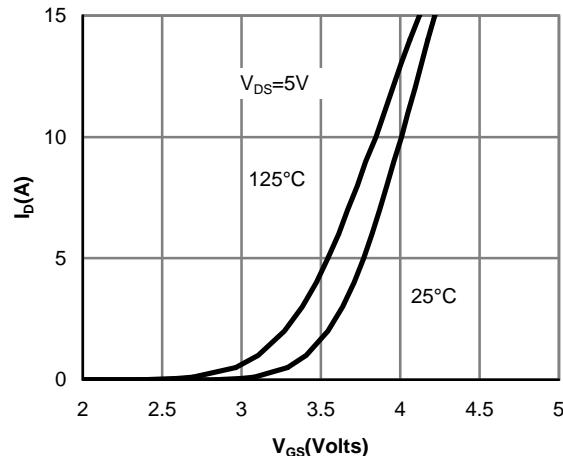


Figure 2: Transfer Characteristics

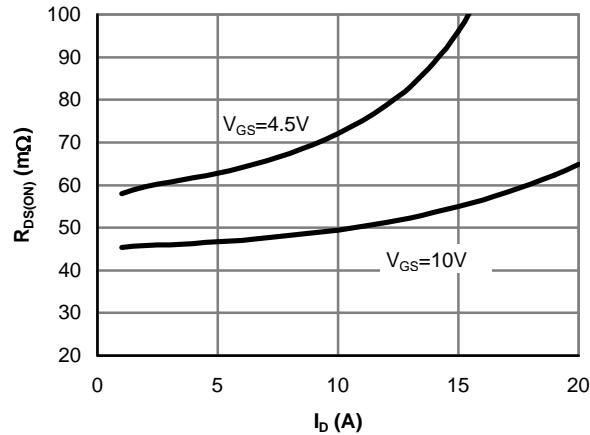


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

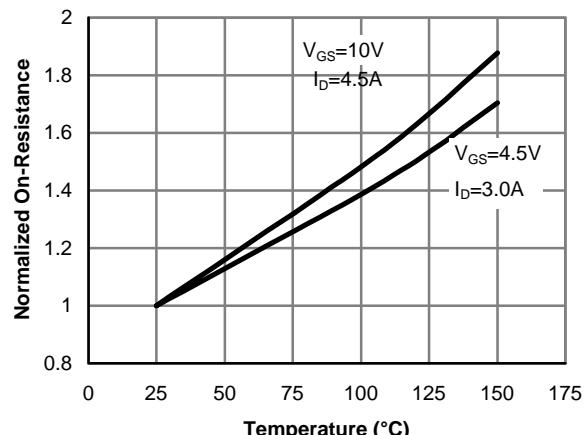


Figure 4: Normalized On-Resistance vs. Junction Temperature

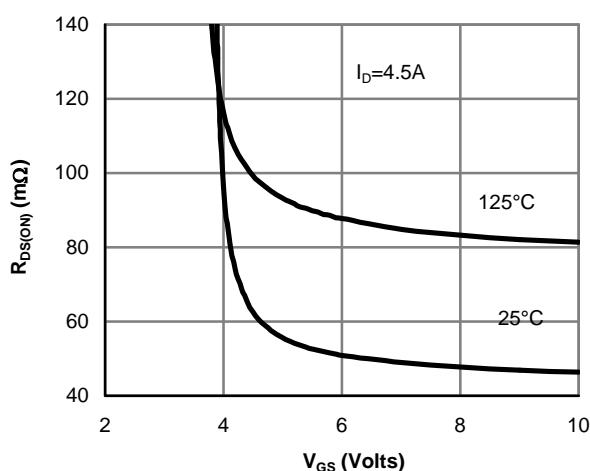


Figure 5: On-Resistance vs. Gate-Source Voltage

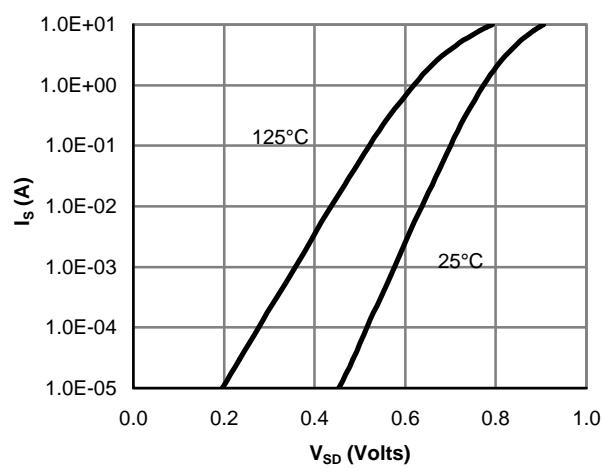


Figure 6: Body-Diode Characteristics

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: N-CHANNEL**

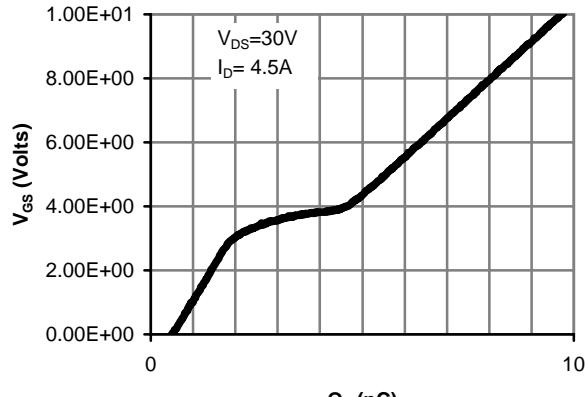


Figure 7: Gate-Charge Characteristics

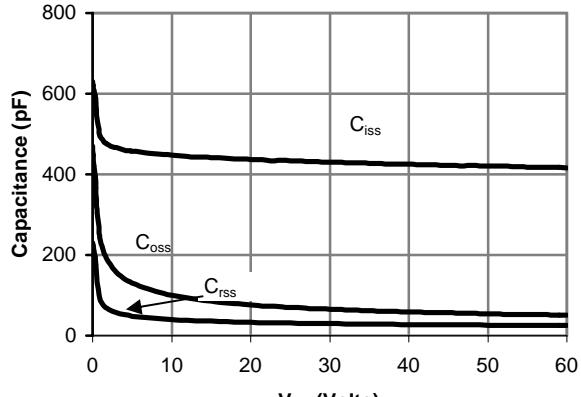


Figure 8: Capacitance Characteristics

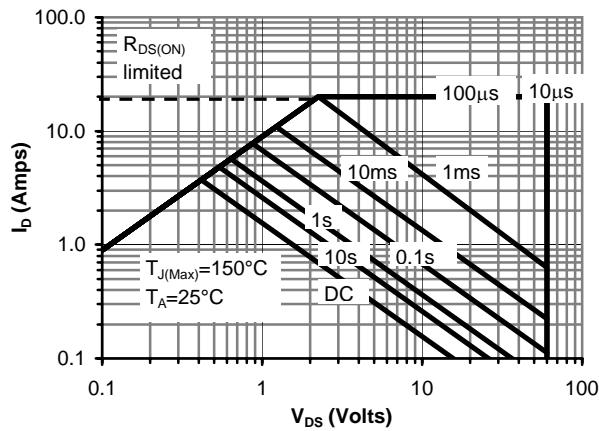


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

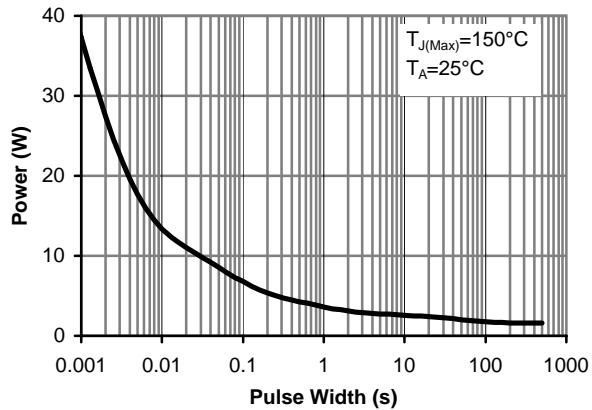


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

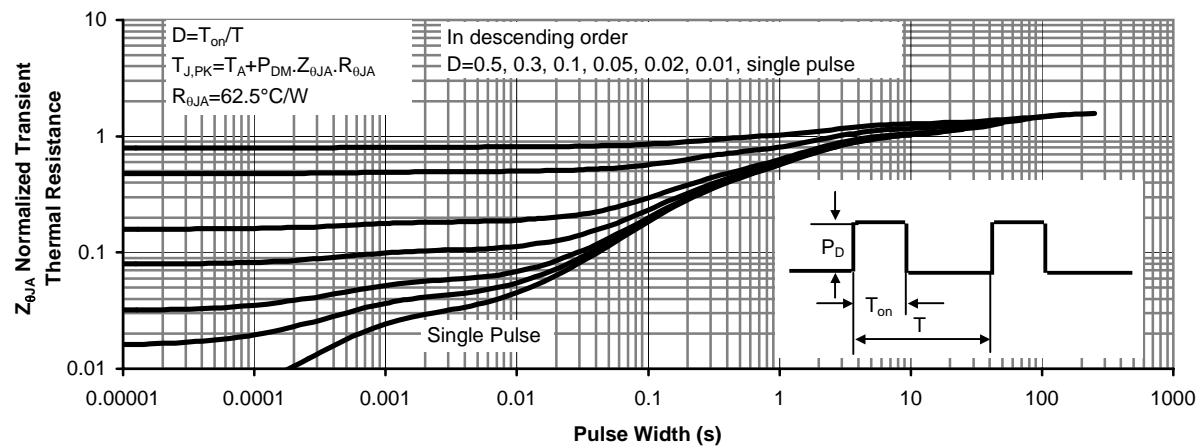


Figure 11: Normalized Maximum Transient Thermal Impedance

**P-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=-250\mu\text{A}$ , $V_{GS}=0\text{V}$	-60			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=-48\text{V}$ , $V_{GS}=0\text{V}$			-1	$\mu\text{A}$
$I_{GSS}$	Gate-Body leakage current	$V_{DS}=0\text{V}$ , $V_{GS}=\pm20\text{V}$			-5	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D=-250\mu\text{A}$	-1	-2.1	-3	V
$I_{D(\text{ON})}$	On state drain current	$V_{GS}=-10\text{V}$ , $V_{DS}=-5\text{V}$	-20			A
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=-10\text{V}$ , $I_D=-3.2\text{A}$		84	105	$\text{m}\Omega$
		$T_J=125^\circ\text{C}$		145		
$g_{FS}$	Forward Transconductance	$V_{DS}=-5\text{V}$ , $I_D=-3.2\text{A}$		9		S
$V_{SD}$	Diode Forward Voltage	$I_S=-1\text{A}$ , $V_{GS}=0\text{V}$		-0.73	-1	V
$I_S$	Maximum Body-Diode Continuous Current				-3	A
<b>DYNAMIC PARAMETERS</b>						
$C_{iss}$	Input Capacitance	$V_{GS}=0\text{V}$ , $V_{DS}=-30\text{V}$ , $f=1\text{MHz}$		930	1120	pF
$C_{oss}$	Output Capacitance			85		pF
$C_{rss}$	Reverse Transfer Capacitance			35		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $f=1\text{MHz}$		7.2	9	$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge (10V)	$V_{GS}=-10\text{V}$ , $V_{DS}=-30\text{V}$ , $I_D=-3.2\text{A}$		16	20	nC
$Q_g(4.5\text{V})$	Total Gate Charge (4.5V)			8	10	nC
$Q_{gs}$	Gate Source Charge			2.5		nC
$Q_{gd}$	Gate Drain Charge			3.2		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=-10\text{V}$ , $V_{DS}=-30\text{V}$ , $R_L=9.4\Omega$ , $R_{\text{GEN}}=3\Omega$		8		ns
$t_r$	Turn-On Rise Time			3.8		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			31.5		ns
$t_f$	Turn-Off Fall Time			7.5		ns
$t_{rr}$	Body Diode Reverse Recovery Time	$I_F=-3.2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		27	35	ns
$Q_{rr}$	Body Diode Reverse Recovery Charge	$I_F=-3.2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$		32		nC

A: The value of  $R_{\text{0JA}}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\text{0JA}}$  is the sum of the thermal impedance from junction to lead  $R_{\text{0JL}}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6, 12, 14 are obtained using 80 $\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: P-CHANNEL**

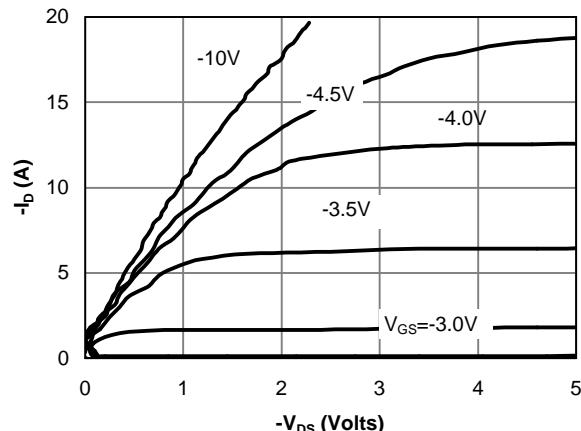


Fig 1: On-Region Characteristics

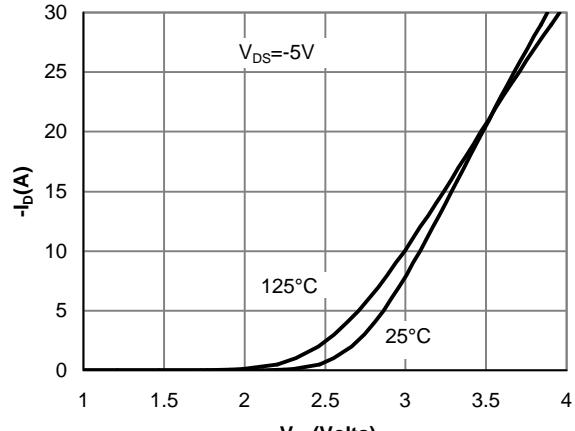


Figure 2: Transfer Characteristics

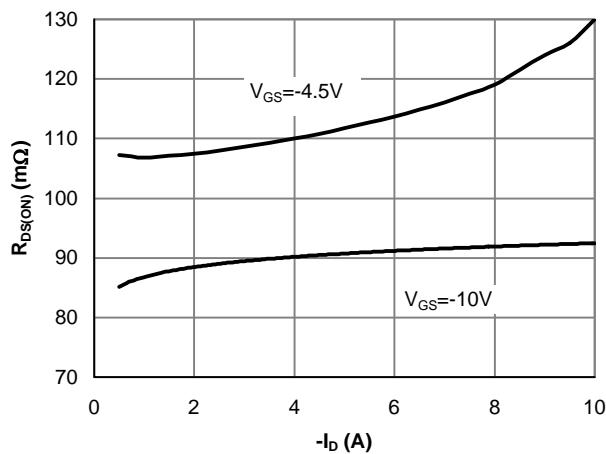


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

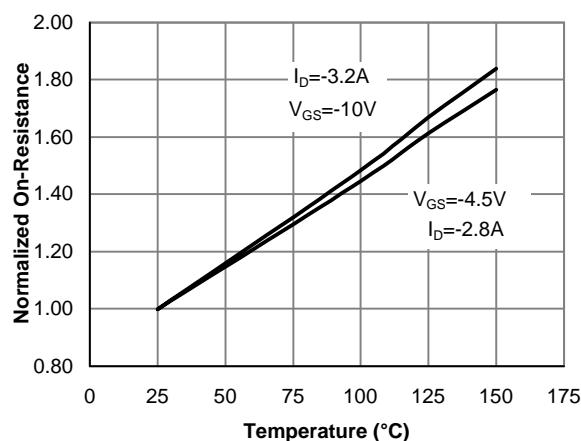


Figure 4: On-Resistance vs. Junction Temperature

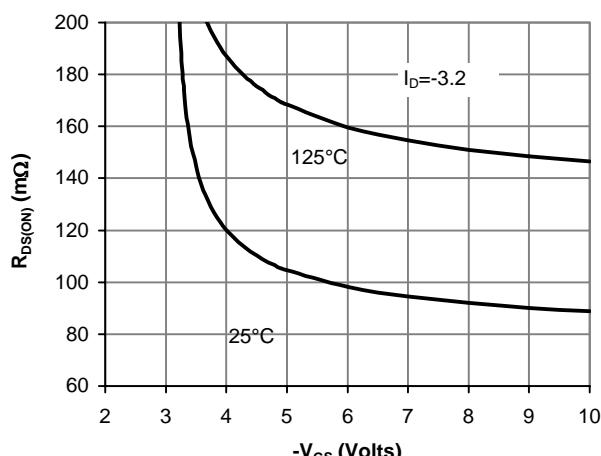


Figure 5: On-Resistance vs. Gate-Source Voltage

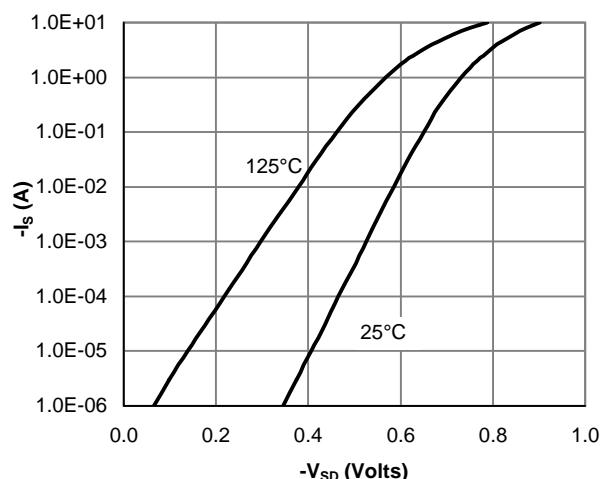
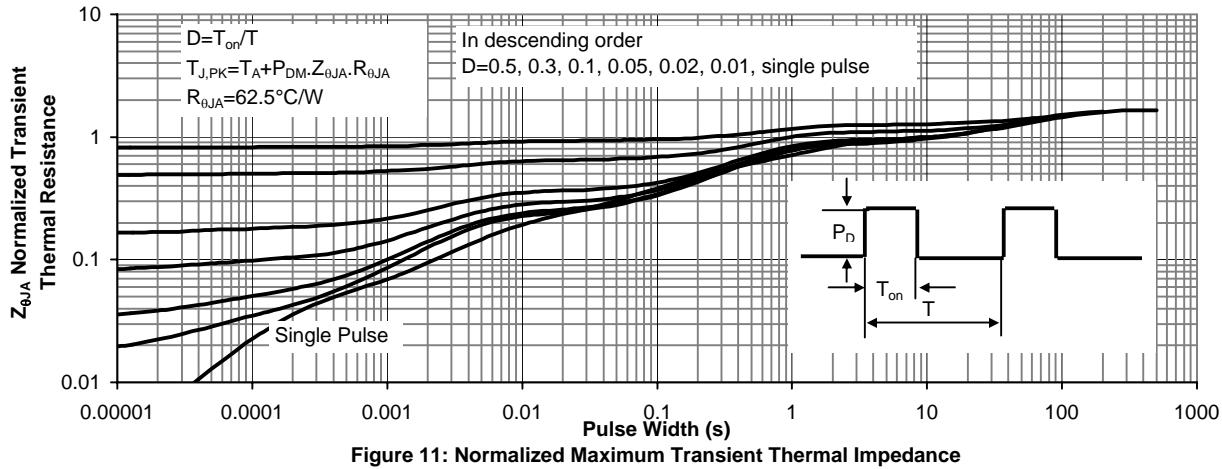
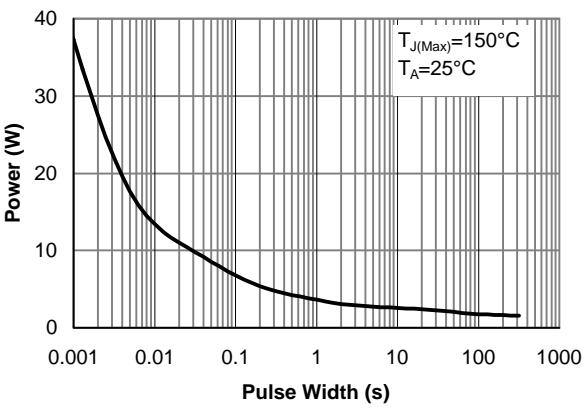
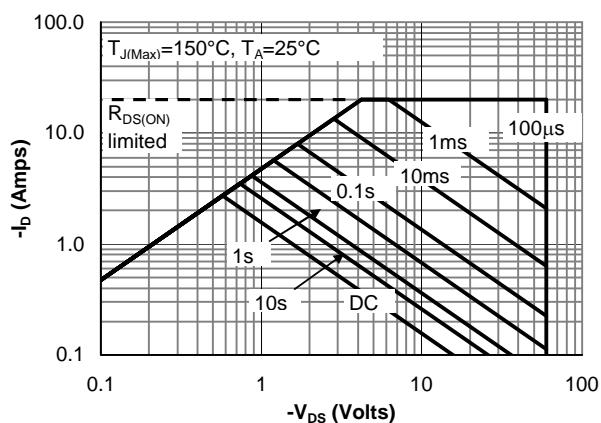
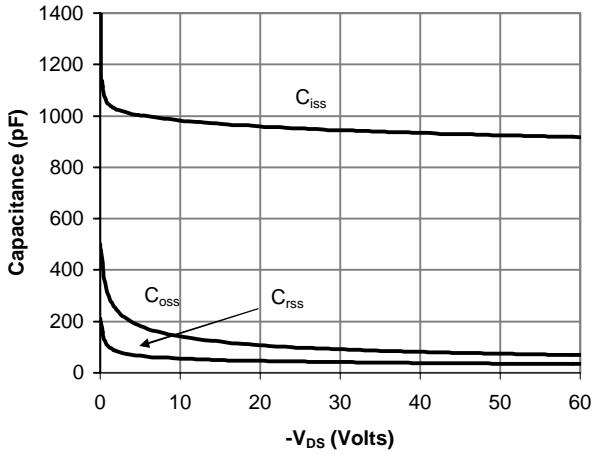
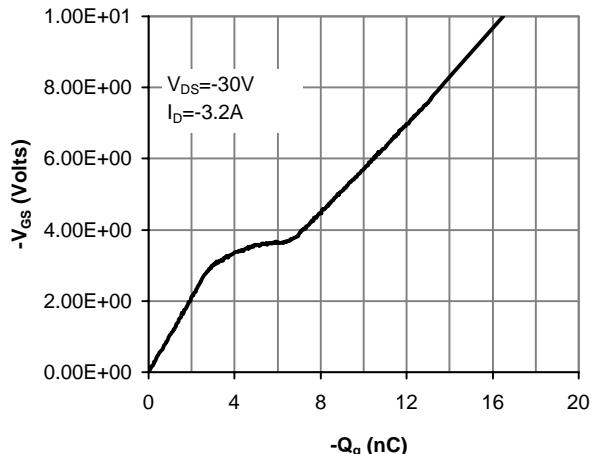
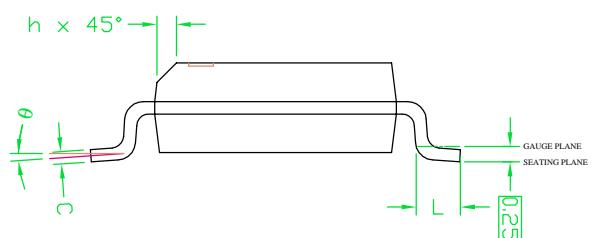
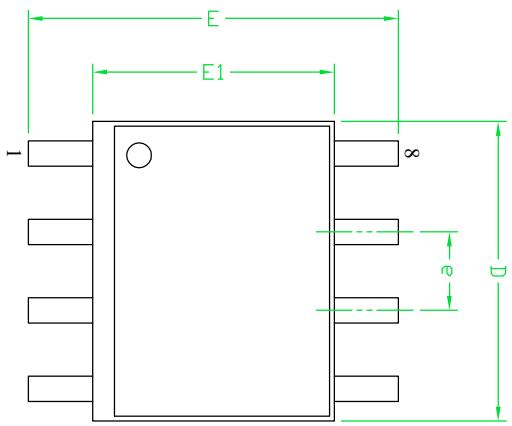


Figure 6: Body-Diode Characteristics

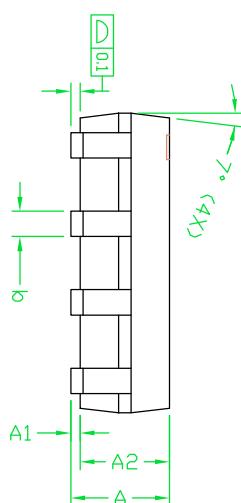
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: P-CHANNEL**



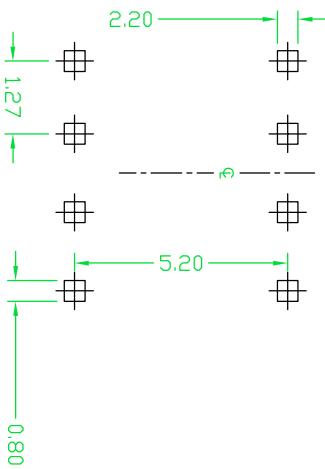


**NOTE**

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONS ARE INCLUSIVE OF PLATING.
3. PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
4. DIMENSION L IS MEASURED IN GAUGE PLANE.
5. CONTROLLING DIMENSION IS MILLIMETER. CONVERTED INCH DIMENSIONS ARE NOT NECESSARILY EXACT.



**RECOMMENDED LAND PATTERN**



**UNIT:** mm

SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.35	1.65	1.75	0.053	0.065	0.069
A1	0.10	—	0.25	0.004	—	0.010
A2	1.25	1.50	1.65	0.049	0.059	0.065
b	0.31	—	0.51	0.012	—	0.020
c	0.17	—	0.25	0.007	—	0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	1.27 BSC			0.050 BSC		
E	5.80	6.00	6.20	0.228	0.236	0.244
h	0.25	—	0.50	0.010	—	0.020
L	0.40	—	1.27	0.016	—	0.050
$\theta$	$0^\circ$			$8^\circ$		

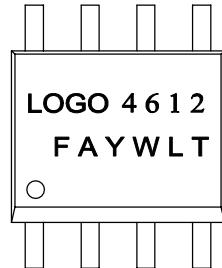
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES		THIRD ANGLE PROJECTION	ALPHA & OMEGA SEMICONDUCTOR, LTD.
DECIMAL	ANGULAR		
$XX \pm$ $XXX \pm$ $XXXX \pm$	$\pm$		
INTERPRET DIM. AND TOL. PER ASME Y14.5M - 1994	Version	Document No.	PD-00004 rev C
PRINTING IS SCALED TO FIT DO NOT SCALE DRAWING	Title	SO-8 PACKAGE OUTLINE	



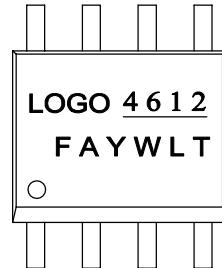
**ALPHA & OMEGA**  
SEMICONDUCTOR, LTD.

Document No.	PD-00238
Version	rev B
Title	AO4612 Marking Description

SO-8 PACKAGE MARKING DESCRIPTION



Standard product



Green product

NOTE:

LOGO - AOS LOGO  
4612 - PART NUMBER CODE.  
F&A - FOUNDRY AND ASSEMBLY LOCATION  
Y - YEAR CODE  
W - WEEK CODE.  
L T - ASSEMBLY LOT CODE

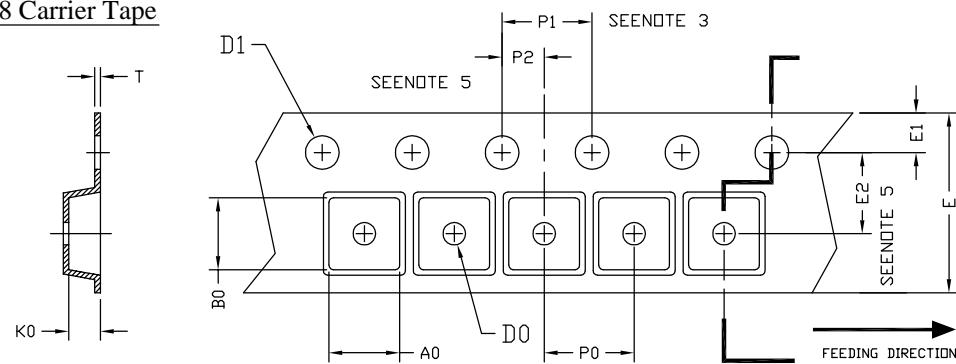
PART NO.	DESCRIPTION	CODE
AO4612	Standard product	4612
AO4612L	Green product	<u>4612</u>



**ALPHA & OMEGA**  
SEMICONDUCTOR, LTD.

## SOP-8 Tape and Reel Data

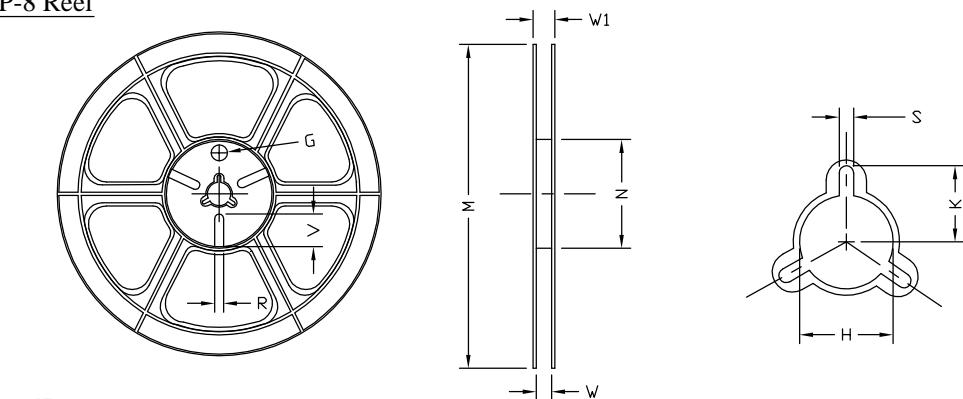
### SOP-8 Carrier Tape



UNIT: MM

PACKAGE	$A_0$	$B_0$	$K_0$	$D_0$	$D_1$	$E$	$E_1$	$E_2$	$P_0$	$P_1$	$P_2$	$T$
SOP-8 <12 mm>	6.40 $\pm 0.10$	5.20 $\pm 0.10$	2.10 $\pm 0.10$	1.60 $\pm 0.10$	1.50 $\pm 0.10$	12.00 $\pm 0.30$	1.75 $\pm 0.10$	5.50 $\pm 0.05$	8.00 $\pm 0.10$	4.00 $\pm 0.10$	2.00 $\pm 0.05$	0.25 $\pm 0.05$

### SOP-8 Reel



UNIT: MM

TAPE SIZE	REEL SIZE	$M$	$N$	$W$	$W_1$	$H$	$K$	$S$	$G$	$R$	$V$
12 mm	$\varnothing 330$	$\varnothing 330.00$ $\pm 0.50$	$\varnothing 97.00$ $\pm 0.10$	13.00 $\pm 0.30$	17.40 $\pm 1.00$	$\varnothing 13.00$ $+0.50$ $-0.20$	10.60	2.00 $\pm 0.50$	---	---	---

### SOP-8 Tape

Leader / Trailer  
& Orientation

